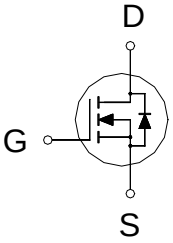
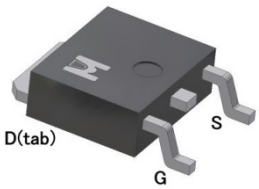
N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	60V
$R_{DSON\ (MAX.)}$	60mΩ
I_D	12A





UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_C = 25 °C	I_D	12	A
	T_C = 100 °C		8	
Pulsed Drain Current[1]		I_{DM}	30	
Avalanche Current		I_{AS}	12	
Avalanche Energy	L = 0.1mH, ID=12A, RG=25Ω	E_{AS}	7.2	mJ
Repetitive Avalanche Energy[2]	L = 0.05mH	E_{AR}	3.6	
Power Dissipation	T_C = 25 °C	P_D	16.6	W
	T_C = 100 °C		6.6	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		7.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$		80	

[1]Pulse width limited by maximum junction temperature.

[2]Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS (T_C = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	60			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.0	2.0	3.2	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 48V, V_{GS} = 0V			1	μA
		V_{DS} = 40V, V_{GS} = 0V, T_J = 125 °C			25	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 10V, V_{GS} = 10V	12			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 10A		50	60	mΩ
		V_{GS} = 5V, I_D = 8A		58	75	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 10A		19		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 20V, f = 1MHz		633		pF
Output Capacitance	C_{oss}			67		
Reverse Transfer Capacitance	C_{rss}			44		
Gate Resistance	R_g	V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz		2.5		Ω
Total Gate Charge[1,2]	Q_g	V_{DS} = 20V, V_{GS} = 10V, I_D = 10A		13.8		nC
Gate-Source Charge[1,2]	Q_{gs}			2.8		
Gate-Drain Charge[1,2]	Q_{gd}			4.0		
Turn-On Delay Time[1,2]	$t_{d(on)}$	V_{DS} = 20V, I_D = 1A, V_{GS} = 10V, R_{GS} = 6Ω		10		nS
Rise Time[1,2]	t_r			7.5		
Turn-Off Delay Time[1,2]	$t_{d(off)}$			18		
Fall Time[1,2]	t_f			6		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				12	A
Pulsed Current[3]	I_{SM}				48	
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	I_F = 5A, dI_F/dt = 100A / μS		15		nS
Reverse Recovery Charge	Q_{rr}			8		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.